TRANSISTORS

Transistor – a three-terminal device for which the voltage or current at one terminal controls the electrical behavior of the other terminals.

Bipolar Junction Transistor (BJT) – a three-terminal device for which the current at one terminal controls the electrical behavior of the other terminals.



Current-Controlled (Dependent) Current Source $i_2 = \beta i_1$

Field Effect Transistor (FET) – a three-terminal device for which a voltage related to one terminal controls the electrical behavior of the other terminals.



Voltage-Controlled (Dependent) Current Source $i_2 = g v_{13}$

TRANSISTOR IV CHARACTERISTICS

IV Characteristic – the current-voltage behavior of a transistor is often represented as a set of curves, each of which corresponds to a different control current or voltage. The desired operation is limited to specific ranges of current and voltage, e.g. active regions. The nonlinear device must be biased to the desired operating point by an external circuit.

Examples:





Typical Applications

- Signal Amplification a small signal is replicated and amplified
- Switching a low-power input controls a high power output
- Logic Operations a digital logic function is implemented

Transistors may be implemented in semiconductors as discrete devices or as integrated circuits.

BIPOLAR JUNCTION TRANSISTOR

Bipolar Junction Transistor (BJT) – device formed by a p-type material between two n-type materials or an n-type material between two p-type materials.





 $E_{\rm F}$

BJT OPERATING CONDITIONS

BJT Operating Conditions

- Base-Emitter Junction Forward Bias
- Collector-Base Junction Reverse Bias



Base-Emitter Junction under Forward Bias

- Junction width narrows
- Diffusion current dominates
- Holes injected into the emitter region
- Electrons injected (emitted) into the base region

Base-Collector Junction under Reverse Bias

- Junction width broadens
- Drift current dominates
- Holes extracted from collector region near the junction
- Electrons extracted (collected) from base region near the junction

Desired Operation

Electrons injected from the emitter into the base diffuse across the undepleted base region and are captured by the high electric field in the base-collector junction. Electrons lost to recombination in the base region do not contribute to the collector current.

The design depends on the width of the base region, a diffusion coefficient for electrons, and the average recombination lifetime for electrons.

BJT CURRENTS

BJT Currents – a summary of important currents in an npn transistor is shown below. (Some secondary effects are omitted.)

- Emitter electron current i_{En} and hole current i_{Ep}
- Collector current $i_C \sim i_{Cn}$
- Base current $i_B \sim i_{Bp}$
- Reverse-bias thermally-generated emitter-base current (neglected in further analysis)



The emitter injection efficiency $\gamma = i_{En}/(i_{En} + i_{Ep})$ The base transport factor $\alpha_F = i_{Cn}/i_{En}$ Then, the current transfer ratio

 $\alpha_o = i_C/i_E \sim (i_{Cn}/i_E) = (i_{Cn}/i_{En}) [i_{En}/(i_{En} + i_{Ep})] = \alpha_F \gamma$ Kirchhoff's Current Law for the transistor gives

$$+ i_{\rm C} + i_{\rm B} - i_{\rm E} = 0$$
 or $+ i_{\rm B} = + i_{\rm E} - i_{\rm C}$

Hence, the gain is

$$\beta = i_C/i_B = i_C/(i_E - i_C) = (i_C/i_E)/[1 - (i_C/i_E)] = (\alpha_o)/[1 - (\alpha_o)]$$

To produce a large gain β , the current transfer ratio α_0 (and the base transport factor α_F and the emitter injection efficiency γ) must be near unity.

Design optimization

- Highly doped emitter (n+): $i_E \sim i_{En}$ and $\gamma = i_{En}/(i_{En} + i_{Ep})$ is near unity
- Narrow base width and light base doping: little recombination in the base region (i.e. α_F is near unity)

Note that the emitter and collector are typically doped differently.

BJT OPERATING CONDITIONS

BJT Operating Conditions

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- Collector-Base Junction Reverse Bias



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- Holes extracted (collected) from base region near the junction

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Holes injected from the emitter into the base diffuse across the undepleted base region and are captured by the high electric field in the base-collector junction. Holes lost to recombination in the base region do not contribute to the collector current.

The design depends on the width of the base region, a diffusion coefficient for holes, and the average recombination lifetime for holes.

BJT CURRENTS

BJT Currents – a summary of important currents in a pnp transistor is shown below. (Some secondary effects are omitted.)

- Emitter electron current i_{En} and hole current i_{Ep}
- Collector current $i_C \sim i_{Cp}$
- Base current $i_B \sim i_{Bn}$
- Reverse-bias thermally-generated emitter-base current (neglected in further analysis)



The emitter injection efficiency $\gamma = i_{Ep}/(i_{En} + i_{Ep})$ The base transport factor $\alpha_F = i_{Cp}/i_{Ep}$ Then, the current transfer ratio

 $\alpha_{o} = i_{C}/i_{E} \sim (i_{Cp}/i_{E}) = (i_{Cp}/i_{Ep}) [i_{Ep}/(i_{En} + i_{Ep})] = \alpha_{F} \gamma$ Kirchhoff's Current Law for the transistor gives $+ i_{C} + i_{B} - i_{E} = 0$ or $+ i_{B} = + i_{E} - i_{C}$

Hence, the gain is

$$\beta = i_{\rm C}/i_{\rm B} = i_{\rm C}/(i_{\rm E} - i_{\rm C}) = (i_{\rm C}/i_{\rm E})/[1 - (i_{\rm C}/i_{\rm E})] = (\alpha_{\rm o})/[1 - (\alpha_{\rm o})]$$

To produce a large gain β , the current transfer ratio α_0 (and the base transport factor α_F and the emitter injection efficiency γ) must be near unity.

Design optimization

- Highly doped emitter (p+): $i_E \sim i_{Ep}$ and $\gamma = i_{Ep}/(i_{En} + i_{Ep})$ is near unity
- Narrow base width and light base doping: little recombination in the base region (i.e. α_F is near unity)

Note that the emitter and collector are typically doped differently.

SUMMARY OF BJT BEHAVIOR

The bipolar junction transistor current amplification with gain $\beta = i_C/i_B$.



npn BJT Operating Conditions

- Forward Bias of Base-Emitter Junction $v_{BE} > turn-on voltage$
- Reverse Bias of Collector-Base Junction $v_{BC} < 0$ or $v_{CB} > 0$





pnp BJT Operating Conditions

- Forward Bias of Base-Emitter Junction $v_{EB} > turn-on voltage$
- Reverse Bias of Collector-Base Junction $v_{CB} < 0$ or $v_{BC} > 0$

Regions in the Common-Emitter IV Characteristic

- Saturation the base-collector junction is not reverse biased for low values of v_{CE} (npn) or v_{EC} (pnp) and i_C is not proportional to i_B .
- Active the normal operating region in which $i_c = \beta i_B$.
- Breakdown (not shown) the active region limit for large values of v_{CE} (npn) or v_{EC} (pnp) when breakdown occurs in the collector-base junction

Other secondary effects may be considered for more accurate representations, but these effects are beyond the scope of this class.

COMMON-BASE BJT CIRCUIT AND ANALYSIS

Common-Base Biasing Circuit with a pnp BJT

- Forward Bias of Base-Emitter Junction $v_{EB} > turn-on voltage$
- Reverse Bias of Collector-Base Junction $v_{CB} < 0$ or $v_{BC} > 0$



Analysis for Operating Point (v_{BC} , i_C) with $v_S = 0$.

 $\begin{array}{l} \mbox{Kirchhoff's-Voltage-Law on Emitter Side } (v_{EC} = V_{to}): \\ - V_{EE} + i_E \; R_e + V_{to} \; = 0 \quad \mbox{or} \quad i_E = (1/R_e)(V_{EE} - V_{to}) \\ \mbox{ord} \end{array}$

and

 $i_{\rm C} = \alpha_0 i_{\rm E} = (\alpha_0/R_e)(V_{\rm EE} - V_{\rm to})$

Kirchhoff's-Voltage-Law on Collector Side (the Load-Line Equation): $-V_{CC} + i_C R_c + v_{BC} = 0$ or $v_{BC} = V_{CC} - i_C R_c$



COMMON-EMITTER BJT AMPLIFIER AND ANALYSIS

Common-Emitter Biasing Circuit with an npn BJT

- Forward Bias of Base-Emitter Junction $v_{BE} > turn-on voltage$
- Reverse Bias of Collector-Base Junction $v_{BC} < 0$ or $v_{CB} > 0$



Analysis for Operating Point (v_{CE} , i_C) with $v_S = 0$.

Kirchhoff's-Voltage-Law on Base Side ($v_{BE} = V_{to}$):

- $V_{BB} + i_B R_b + V_{to} = 0$ or $i_B = (1/R_b)(V_{BB} - V_{to})$ and

 $i_C = \beta i_B = (\beta/R_b)(V_{BB} - V_{to})$

Kirchhoff's-Voltage-Law on Collector Side (the Load-Line Equation): $-V_{CC} + i_C R_c + v_{CE} = 0$ or $v_{CE} = V_{CC} - i_C R_c$

With no signal $v_{S} = 0$ $V_{o} = i_{C}R_{c} = (\beta R_{c}/R_{b})(V_{BB} - V_{to})$ With a signal v_{S} $V_{o} = i_{C}R_{c} = (\beta R_{c}/R_{b})(V_{BB} - V_{to}) + (\beta R_{c}/R_{b})(v_{S})$ Graphical Analysis Load-Line $-V_{CC} + i_{C}R_{c} + v_{CE} = 0$

Intercepts $v_{CE} = V_{CC}$ $i_C = V_{CC}/R_c$



COMMON-EMITTER BJT AMPLIFIER AND ANALYSIS

Common-Emitter Biasing Circuit with a pnp BJT

- Forward Bias of Base-Emitter Junction $v_{EB} > turn-on voltage$
- Reverse Bias of Collector-Base Junction $v_{CB} < 0$ or $v_{BC} > 0$



Analysis for Operating Point (v_{EC} , i_C) with $v_S = 0$.

 $-V_{CC} + i_C R_c + v_{EC} = 0$

Kirchhoff's-Voltage-Law on Base Side ($v_{EB} = V_{to}$):

- $V_{BB} + i_B R_b + V_{to} = 0$ or $i_B = (1/R_b)(V_{BB} - V_{to})$ and

 $i_C = \beta i_B = (\beta/R_b)(V_{BB} - V_{to})$

Kirchhoff's-Voltage-Law on Collector Side (the Load-Line Equation): $-V_{CC} + i_C R_c + v_{EC} = 0$ or $v_{EC} = V_{CC} - i_C R_c$

With no signal $v_{S} = 0$ $V_{o} = i_{C}R_{c} = (\beta R_{c}/R_{b})(V_{BB} - V_{to})$ With a signal v_{S} $V_{o} = i_{C}R_{c} = (\beta R_{c}/R_{b})(V_{BB} - V_{to}) + (\beta R_{c}/R_{b})(v_{S})$ Graphical Analysis Load-Line





DARLINGTON AMPLIFIER AND ANALYSIS

Common-Emitter Biasing Circuit with dual-npn BJT's

- Forward Bias of Base-Emitter Junctions $v_{BE} > turn-on voltage$
- Reverse Bias of Collector-Base Junctions $v_{BC} < 0$ or $v_{CB} > 0$



Kirchhoff's-Voltage-Law on Base Side ($v_{BE1} = v_{BE2} = V_{to}$):

- $(V_{BB} + v_S) + i_{B1} R_b + 2V_{to} = 0$ or $i_{B1} = (1/R_b)[(V_{BB} + v_S) - 2V_{to}]$ and

 $i_{C1} = \beta_1 i_{B1} = (\beta_1/R_b)[(V_{BB} + v_S) - 2V_{to}]$

Also, noting that $\beta_1/\alpha_{o1} = 1 + \beta_1$

$$\begin{split} &i_{C2} = \beta_2 i_{B2} = \beta_2 i_{E1} = \beta_2 i_{C1} / \alpha_{o1} = \beta_2 \beta_1 i_{B1} / \alpha_{o1} = \beta_2 (1 + \beta_1) i_{B1} \\ &i_{C2} = \beta_2 (1 + \beta_1) (1 / R_b) [\ (V_{BB} + v_S) \ \text{-} 2V_{to}] \end{split}$$

Then,

$$i_{C1} + i_{C2} = [\beta_1 + \beta_2(1 + \beta_1)] \{ (1/R_b) [(V_{BB} + v_S) - 2V_{to}] \}$$

$$i_{C1} + i_{C2} = [\beta_1 + \beta_2 + \beta_1\beta_2] \{ (1/R_b) [(V_{BB} + v_S) - 2V_{to}] \}$$

The output voltage is

 $\mathbf{V}_{o} = (\mathbf{i}_{C1} + \mathbf{i}_{C2})\mathbf{R}_{c} = [\beta_{1} + \beta_{2} + \beta_{1}\beta_{2}]\{(\mathbf{R}_{c}/\mathbf{R}_{b}) [(\mathbf{V}_{BB} + \mathbf{v}_{S}) - 2\mathbf{V}_{to}]\}$

Note that the overall gain of the dual-transistor configuration is $\beta_{Dual} = (i_{C1} + i_{C2})/i_{B1} = (\beta_1 + \beta_2 + \beta_1\beta_2)$

If the transistors are identical with a large gain ($\beta_1 = \beta_2 = \beta >>1$), $\beta_{Dual} = (i_{C1} + i_{C2})/i_{B1} = \beta(2 + \beta) \sim \beta^2$

The overall gain can be increased further with additional transistors.

COMMON-EMITTER BJT AMPLIFIER VARIATION

Common-Emitter Biasing Circuit with a pnp BJT

- Forward Bias of Base-Emitter Junction $v_{EB} > turn-on voltage$
- Reverse Bias of Collector-Base Junction $v_{CB} < 0$ or $v_{BC} > 0$



Analysis for Operating Point (v_{EC},i_C) with $v_S = 0$.

Kirchhoff's-Voltage-Law on Base Side ($v_{EB} = V_{to}$): $-V_{BB} + i_B R_b + i_E R_e + V_{to} = 0$ Since $\beta/\alpha_o = 1 + \beta$ and $i_C = \alpha_o i_E = \beta i_B$, then $i_E = (1 + \beta) i_B$ and $i_B = (V_{BB} - V_{to})/[R_e(1 + \beta) + R_b]$ or $i_E = (V_{BB} - V_{to})/[R_e + R_b/(1 + \beta)]$ Also, $i_C = \beta i_B = (V_{BB} - V_{to})/[R_e(1 + \beta)/(\beta) + R_b/(\beta)]$ Kirchhoff's-Voltage-Law on Collector Side (the Load-Line Equation): $-V_{CC} + i_C R_c + i_E R_e + v_{EC} = 0$ or $v_{EC} = V_{CC} - i_C R_c - i_E R_e$ If $\beta >> 1$, then $i_C \sim (V_{BB} - V_{to})/[R_e + R_b/(\beta)]$ If $R_e >> R_b/(\beta)$, then $i_C \sim (V_{BB} - V_{to})/[R_e)$ With no signal $v_S = 0$ $V_o = i_C R_c = (R_c/R_e)(V_{BB} - V_{to})$ With a signal v_S

$$V_o = i_C R_c = (R_c/R_e)(V_{BB} - V_{to}) + (R_c/R_e)(v_S)$$

Note that for $v_s = 0$, this circuit serves as a constant current source, i.e. the current does not depend on the load resistance R_c .

COMMON-EMITTER CIRCUITS WITH COUPLING CAPACITORS

Coupling Capacitor in pnp BJTs Common-Emitter Circuits



Separating Signal v_{S} and Biasing Source V_{BB}

CONSTANT CURRENT SOURCE WITH BJT

Constant Current Source (Common-Emitter) Circuit with an npn BJT

- Forward Bias of Base-Emitter Junctions $v_{BE} > turn-on voltage$
- Reverse Bias of Collector-Base Junctions $v_{BC} < 0$ or $v_{CB} > 0$

Consider the voltage source and the resistors R_1 and R_2 separately.

The Thevenin equivalent with respect to the Base node and the reference node has

$$V_{BB} = V_{TH} = V_{CC} [R_2/(R_1 + R_2)]$$

$$R_b = R_{TH} = R_1 ||R_2 = [R_1 R_2 / (R_1 + R_2)]$$



The equivalent circuit is



As before, the operating point (v_{CE}, i_C) is $i_C = \beta i_B = (V_{BB} - V_{to})/[R_e(1 + \beta)/(\beta) + R_b/(\beta)]$ from KVL on base side $v_{CE} = V_{CC} - i_C R_c - i_E R_e$ from KVL on collector side

If $\beta >>1$, then i_C ~ (V_{BB} - V_{to})/[R_e + R_b/(β)] (no dependence on R_c)

If
$$R_e \gg R_b/(\beta)$$
, then $i_C \sim (V_{BB} - V_{to})/(R_e)$
 $V_o = i_C R_c = (R_c/R_e)(V_{BB} - V_{to})$

Only one voltage source is needed.

EMITTER-FOLLOWER BJT CIRCUIT AND ANALYSIS

Emitter-Follower Biasing Circuit with an npn BJT

- Forward Bias of Base-Emitter Junction $v_{BE} > turn-on voltage$
- Reverse Bias of Collector-Base Junction $v_{BC} < 0$ or $v_{CB} > 0$



Analysis for Operating Point (v_{CE} , i_C) with $v_S = 0$.

$$\begin{split} \text{Kirchhoff's-Voltage-Law on Base Side } (v_{BE} = V_{to}): \\ & - V_{BB} + i_B R_b + i_E R_e + V_{to} = 0 \\ \text{Since } \beta/\alpha_o = 1 + \beta \text{ and } i_C = \alpha_o i_E = \beta i_B, \text{ then } i_E = (1 + \beta) i_B \\ \text{and} \\ & i_B = (V_{BB} - V_{to}) / [R_e(1 + \beta) + R_b] \text{ or} \\ & i_E = (V_{BB} - V_{to}) / [R_e + R_b / (1 + \beta)] \\ \text{Also,} \\ & i_C = \beta i_B = (V_{BB} - V_{to}) / [R_e(1 + \beta) / (\beta) + R_b / (\beta)] \end{split}$$

$$\label{eq:constraint} \begin{split} \text{Kirchhoff's-Voltage-Law on Collector Side (the Load-Line Equation):} \\ \text{-} V_{CC} + i_E R_e + v_{CE} = 0 \quad \text{or} \quad v_{CE} = V_{CC} \text{-} i_E R_e \end{split}$$

If
$$R_e \gg R_b/(1 + \beta)$$
, then $i_E \sim (V_{BB} - V_{to})/(R_e)$
With no signal $v_S = 0$
 $V_o = i_E R_e = (V_{BB} - V_{to})$
With a signal v_S
 $V_o = i_E R_e = (V_{BB} - V_{to}) + (v_S)$

MULTIPLE-TRANSISTOR CIRCUITS

Differential Amplifier with npn BJTs



TRANSISTORS FIELD EFFECT TRANSISTOR

Transistor – a three-terminal device for which the voltage or current at one terminal controls the electrical behavior of the other terminals.

Field Effect Transistor (FET) – a three-terminal device for which a voltage related to one terminal controls the electrical behavior of the other terminals.



Voltage-Controlled (Dependent) Current Source $i_2 = g v_{13}$



TRANSISTORS FIELD EFFECT TRANSISTOR

Junction Field Effect Transistor (JFET) – device formed by an n-type channel between two p-type materials or a p-type channel between two n-type materials.

Terminal Nomenclature Gate (G), Drain (D), and Source (S)





JFET OPERATING CONDITIONS

JFET Operating Conditions for n-Channel

• Gate-Channel Junction – Reverse Bias



Gate-Channel Junction under Reverse Bias

- Junction width broadens
- Drift current dominates (and is small)

Channel provides Drain-Source current path

- Current (mainly electrons) in the n-channel is dependent upon dimensions of undepleted channel
- Electrons travel from Source to Drain in the channel

Desired Operation

Current (mainly electrons) travels through the channel. The depletion region of the Gate-Channel junction constricts the channel as a function of Gate-Channel reverse bias and limits the current increase. As the depletion regions close the channel, further current increases go to zero and the channel is in saturation.

The design depends on the dimensions of the channel, the doping levels of the gate and channel, and breakdown characteristics of the gate-channel junction.

JFET PARAMETERS

JFET Current and Voltages – a summary of important current and voltages in an nchannel field-effect transistor is shown below. (Some secondary effects are omitted.)

- Drain-Source Voltage v_{DS} and Current i_{DS}
- Gate-Source Voltage v_{GS}
- Reverse-bias thermally-generated gate-channel current (neglected in further analysis) Gate-Channel current ~ 0



Note that the Gate regions are electrically connected.

Pinch-off Voltage V_{po} : Gate-Channel Reverse-bias Voltage for which the opposite depletion regions merge

Saturation Current I_{DSS} : Drain-Source Current for saturation conditions (maximum current for $v_{GS} = 0$)

Note that the Gate-Channel Voltage varies as a function of position.

Design optimization

• Highly doped gate regions (p+): depletion regions extend primarily into the channel



JFET CHARACTERISTIC

Unsaturated Region with $v_{GS} = 0$ and $V_{po} > v_{DS} > 0$: i_{DS} increases, but • at a decreasing rate due to channel constriction and

 $i_{DS} = I_{DSS} [2(v_{DS}/V_{po}) - (v_{DS}/V_{po})^2]$

- Saturation Region with v_{GS} = 0 and v_{DS} > V_{po} > 0: i_{DS} = I_{DSS} (current • maintains the pinch-off condition with no further current increase)
- Influence of Gate-Channel bias $(-V_{po} < v_{GS} < 0)$: • Unsaturated: $i_{DS} = I_{DSS} [2(1 + v_{GS}/V_{po}) (v_{DS}/V_{po}) - (v_{DS}/V_{po})^2]$ Saturation: $i_{DS} = I_{DSS}(1 + v_{GS}/V_{po})^2$

JFET OPERATING CONDITIONS

JFET Operating Conditions for p-Channel

• Gate-Channel Junction – Reverse Bias

Gate-Channel Junction under Reverse Bias

- Junction width broadens
- Drift current dominates (and is small)

Channel provides Drain-Source current path

- Current (mainly holes) in the p-channel is dependent upon dimensions of undepleted channel
- Holes travel from Source to Drain in the channel

Desired Operation

Current (mainly holes) travels through the channel. The depletion region of the Gate-Channel junction constricts the channel as a function of Gate-Channel reverse bias and limits the current increase. As the depletion regions close the channel, further current increases go to zero and the channel is in saturation.

The design depends on the dimensions of the channel, the doping levels of the gate and channel, and breakdown characteristics of the gate-channel junction.

JFET PARAMETERS

JFET Current and Voltages – a summary of important current and voltages in a pchannel field-effect transistor is shown below. (Some secondary effects are omitted.)

- Source-Drain Voltage v_{SD} and Current i_{SD}
- Source-Gate Voltage v_{SG}
- Reverse-bias thermally-generated gate-channel current (neglected in further analysis) Gate-Channel current ~ 0

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Pinch-off Voltage V_{po} : Gate-Channel Reverse-bias Voltage for which the opposite depletion regions merge

Saturation Current I_{SDS}: Source-Drain Current for saturation conditions (maximum current for $v_{SG} = 0$)

Note that the Gate-Channel Voltage varies as a function of position.

Design optimization

• Highly doped gate regions (n+): depletion regions extend primarily into the channel

JFET CHARACTERISTIC

- Un-biased ($v_{SG} = 0$ and $v_{SD} = 0$): $i_{SD} = 0$
- Unsaturated Region with $v_{SG} = 0$ and $V_{po} > v_{SD} > 0$: i_{SD} increases, but at a decreasing rate due to channel constriction and

 $i_{SD} = I_{SDS} [2(v_{SD}/V_{po}) - (v_{SD}/V_{po})^2]$

- Saturation Region with $v_{SG} = 0$ and $v_{SD} > V_{po} > 0$: $i_{SD} = I_{SDS}$ (current maintains the pinch-off condition with no further current increase)
- Influence of Gate-Channel bias $(-V_{po} < v_{SG} < 0)$: Unsaturated: $i_{SD} = I_{SDS}[2(1 + v_{SG}/V_{po}) (v_{SD}/V_{po}) - (v_{SD}/V_{po})^2]$ Saturation: $i_{SD} = I_{SDS}(1 + v_{SG}/V_{po})^2$

CONDITIONS FOR JFET SATURATION

JFET Saturation Conditions for n-Channel

• Gate-Drain Junction at Reverse-Bias pinch-off voltage Vpo

n-Channel JFET

Kirchhoff's-Voltage-Law for n-channel JFET:

- v_{GS} - v_{DG} + v_{DS} = 0 or v_{DG} = v_{DS} - v_{GS}

General pinch-off condition including influence of Gate-Channel bias: $v_{DG} = v_{DS} - v_{GS} \ge V_{po}$

- Unsaturated Region of Operation: $V_{po} > v_{DS} v_{GS} > 0$ $i_{DS} = I_{DSS}[2(1 + v_{GS}/V_{po}) (v_{DS}/V_{po}) - (v_{DS}/V_{po})^2]$
- Saturation Region of Operation: $v_{DS} v_{GS} \ge V_{po} > 0$ $i_{DS} = I_{DSS}(1 + v_{GS}/V_{po})^2$ for $-V_{po} < v_{GS} < 0$

The IV characteristic is continuous at the threshold of saturation.

Let $v_{DS} - v_{GS} = V_{po}$ or $v_{DS} = V_{po} + v_{GS}$

$$\begin{split} &i_{DS} = I_{DSS}[2(1 + v_{GS}/V_{po}) (v_{DS}/V_{po}) - (v_{DS}/V_{po})^2] \\ &i_{DS} = I_{DSS}\{2(1 + v_{GS}/V_{po}) \left[(V_{po} + v_{GS})/V_{po} \right] - \left[(V_{po} + v_{GS})/V_{po} \right]^2 \} \\ &i_{DS} = I_{DSS}[(2 + 2v_{GS}/V_{po}) (1 + v_{GS}/V_{po}) - (1 + v_{GS}/V_{po})^2] \\ &i_{DS} = I_{DSS}[2 + 4v_{GS}/V_{po} + 2(v_{GS}/V_{po})^2 - 1 - 2 v_{GS}/V_{po} - (v_{GS}/V_{po})^2] \\ &i_{DS} = I_{DSS}[1 + 2v_{GS}/V_{po} + (v_{GS}/V_{po})^2] \\ &i_{DS} = I_{DSS}[1 + v_{GS}/V_{po}]^2 \end{split}$$

General pinch-off condition for p-channel JFET

 $v_{GD} = v_{SD} - v_{SG} \ge V_{po}$

- Unsaturated Region of Operation: $V_{po} > v_{SD} v_{SG} > 0$ $i_{SD} = I_{SDS}[2(1 + v_{SG}/V_{po}) (v_{SD}/V_{po}) - (v_{SD}/V_{po})^2]$
- Saturation Region of Operation: $v_{SD} v_{SG} \ge V_{po} > 0$ $i_{SD} = I_{SDS}(1 + v_{SG}/V_{po})^2$ for $-V_{po} < v_{SG} < 0$

SUMMARY OF JFET BEHAVIOR

The junction field effect transistor with pinch-off voltage V_{po}

n-Channel JFET Operating Conditions

• Reverse Bias of Gate-Channel Junction: $v_{DS} > 0$ and $-V_{po} < v_{GS} < 0$ $i_{DS} = I_{DSS}[2(1 + v_{GS}/V_{po}) (v_{DS}/V_{po}) - (v_{DS}/V_{po})^2]$ and $i_{DS} = I_{DSS}(1 + v_{GS}/V_{po})^2$.

p-Channel JFET

p-Channel JFET Operating Conditions

• Reverse Bias of Gate-Channel Junction: $v_{SD} > 0$ and $-V_{po} < v_{SG} < 0$ $i_{SD} = I_{SDS}[2(1 + v_{SG}/V_{po}) (v_{SD}/V_{po}) - (v_{SD}/V_{po})^2]$ and $i_{SD} = I_{SDS}(1 + v_{SG}/V_{po})^2$.

Regions in the JFET IV Characteristic

- Unsaturated Region the channel is below pinch-off and the current i_{DS} varies strongly with v_{DS} or v_{SD}.
- Saturation Region the channel is above pinch-off and the current i_{DS} varies strongly with v_{GS} or v_{SG} .
- Breakdown (not shown) the limit for large values of v_{DS} (n-channel) or v_{SD} (p-channel) when breakdown occurs in the gate-channel junction

Other secondary effects may be considered for more accurate representations, but these effects are beyond the scope of this class.

COMPARISON OF FET STRUCTURES

Junction Field Effect Transistor (JFET): n-Channel

Metal-Oxide-Semiconductor Field Effect Transistor (MOSFET): Depletion-Mode n-Channel

Base Separate

Base Connected to Source

COMPARISON OF FET STRUCTURES

Junction Field Effect Transistor (JFET): n-Channel

Metal-Oxide-Semiconductor Field Effect Transistor (MOSFET): Enhancement-Mode n-Channel

Base Separate

Base Connected to Source

SUMMARY OF FET TYPES

Junction Field Effect Transistor (JFET): n-Channel and p-channel n-Channel JFET Equations $i_{DS} = I_{DSS}[2(1 + v_{GS}/V_{po})(v_{DS}/V_{po}) - (v_{DS}/V_{po})^2] \& i_{DS} = I_{DSS}(1 + v_{GS}/V_{po})^2.$ The JFET turns on when $0 > v_{GS/SG} > -V_{po}$.

Metal-Oxide-Semiconductor Field Effect Transistors (MOSFET): Depletion-Mode n-Channel and p-Channel (Base connected to Source) Depletion-Mode n-Channel MOSFET Equations $i_{DS} = I_{DSS}[2(1 + v_{GS}/V_{po})(v_{DS}/V_{po}) - (v_{DS}/V_{po})^2] \& i_{DS} = I_{DSS}(1 + v_{GS}/V_{po})^2.$

The Depletion-Mode MOSFET turns on when $v_{GS/SG} > -V_{po}$.

Enhancement-Mode n-Channel and p-Channel (Base connected to Source) Enhancement-Mode n-Channel MOSFET Equations $= -KW^{-2}(2f(x_{e} - M_{e})) - 11(x_{e} - M_{e})^{-2} + 0$

 $i_{DS} = KV_{on}^{2} \{2[(v_{GS}/V_{on}) - 1](v_{DS}/V_{on}) - (v_{DS}/V_{on})^{2}\} \& i_{DS} = KV_{on}^{2}[(v_{GS}/V_{on}) - 1]^{2}.$

The Enhancement-Mode MOSFET turns on when $v_{GS/SG} > V_{on} > 0$.

COMMON-SOURCE JFET CIRCUIT AND ANALYSIS

Common-Source Biasing Circuit with an n-channel JFET

- Reverse Bias of Gate-Channel $-V_{po} < v_{GS} < 0$ and $v_{DS} > 0$
- "On" for $i_{DS} > 0$ and "Off" for $i_{DS} = 0$

Analysis for Operating Point (v_{DS}, i_{DS}).

- The Gate Voltage determines the Drain-Source Current ($V_{GG} = v_{GS}$). For $-V_{po} < v_{GS} < 0$, then $i_{DS} = I_{DSS}(1 + v_{GS}/V_{po})^2$.
- $\label{eq:constraint} \begin{array}{l} \mbox{Kirchhoff's-Voltage-Law on Drain Side (the Load-Line Equation):} \\ \mbox{-} V_{DD} + i_{DS} \; R_d + v_{DS} \; = 0 \quad \mbox{or} \quad v_{DS} = V_{DD} i_{DS} R_d \end{array}$

For operation in the saturation region, the Output Voltage is $V_O = v_{DS} = V_{DD} - i_{DS}R_d = V_{DD} - [I_{DSS}(1 + v_{GS}/V_{po})^2]R_d$

COMMON-SOURCE JFET CIRCUIT AND ANALYSIS

Common-Source Biasing Circuit with a p-channel JFET

- Reverse Bias of Gate-Channel $-V_{po} < v_{SG} < 0$ and $v_{SD} > 0$
- "On" for $i_{SD} > 0$ and "Off" for $i_{SD} = 0$

Analysis for Operating Point (vsD, isD).

The Gate Voltage determines the Drain-Source Current ($V_{GG} = v_{SG}$). For $-V_{po} < v_{SG} < 0$, then $i_{SD} = I_{SDS}(1 + v_{SG}/V_{po})^2$.

 $\label{eq:Kirchhoff's-Voltage-Law on Drain Side (the Load-Line Equation): $-V_{DD} + i_{SD} R_d + v_{SD} = 0$ or $v_{SD} = V_{DD} - i_{SD}R_d$$

For operation in the saturation region, the Output Voltage is $V_O = v_{SD} = V_{DD} - i_{SD}R_d = V_{DD} - [I_{SDS}(1 + v_{SG}/V_{po})^2]R_d$

SOURCE-FOLLOWER JFET CIRCUIT AND ANALYSIS

Source-Follower Biasing Circuit with an n-channel JFET

- Reverse Bias of Gate-Channel $-V_{po} < v_{GS} < 0$ and $v_{DS} > 0$
- "On" for $i_{DS} > 0$ and "Off" for $i_{DS} = 0$

Analysis for Operating Point (v_{DS}, i_{DS}).

Kirchhoff's-Voltage-Law on Gate-Source Side:

- $V_{GG} + i_{DS} R_s + v_{GS} = 0$ or $v_{GS} = V_{GG} - i_{DS} R_s$ and for operation in the saturation region

 $-V_{po} < v_{GS} = (V_{GG} - i_{DS}R_s) < 0$ and $i_{DS} = I_{DSS}(1 + v_{GS}/V_{po})^2$.

 $\label{eq:constraint} \begin{array}{l} \mbox{Kirchhoff's-Voltage-Law on Drain Side (the Load-Line Equation):} \\ \mbox{-} V_{DD} + i_{DS} \; R_s + v_{DS} \; = 0 \quad \mbox{or} \quad v_{DS} = V_{DD} - i_{DS} R_s \end{array}$

For operation in the saturation region, the Output Voltage is $V_O = i_{DS} R_s = I_{DSS} R_s (1 + v_{GS}/V_{po})^2 = I_{DSS} R_s [1 + (V_{GG} - i_{DS} R_s)/V_{po}]^2.$

OTHER COMMON-SOURCE CIRCUITS

Coupling Capacitors in n-Channel JFET Common-Emitter Circuit

Single-Source in n-Channel Enhancement-Mode MOSFET Circuit

Thevenin Equivalent Circuit for Input Voltage

$$V_{GG} = V_{TH} = V_{DD} [R_2/(R_1 + R_2)]$$

$$\mathbf{R}_{\text{TH}} = \mathbf{R}_1 || \mathbf{R}_2 = [\mathbf{R}_1 \mathbf{R}_2 / (\mathbf{R}_1 + \mathbf{R}_2)]$$

SELF-BIASING JFET CIRCUIT

Self-Biasing Circuit with an n-channel JFET

• Reverse Bias of Gate-Channel $-V_{po} < v_{GS} < 0$ and $v_{DS} > 0$

Analysis for Operating Point (VDS, iDS).

$$\begin{split} \text{Kirchhoff's-Voltage-Law for Gate-} \\ \text{Source gives } (i_G = 0). \\ v_{GS} = -i_{DS} R_s \\ \text{For } -V_{po} < v_{GS} < 0, \text{ then} \\ i_{DS} = I_{DSS} (1 + v_{GS}/V_{po})^2 \\ i_{DS} = I_{DSS} [1 + (-i_{DS} R_s)/V_{po}]^2. \end{split}$$

 $R_{g} \xrightarrow{i_{DS}} D_{+} R_{D}$ $R_{g} \xrightarrow{+ v_{GS}} S_{+}$ $R_{S} \xrightarrow{-} S_{+} V_{0} V_{DD}$ -

Self-Biasing Circuit with a p-channel JFET

• Reverse Bias of Gate-Channel $-V_{po} < v_{SG} < 0$ and $v_{SD} > 0$

Analysis for Operating Point (V_{SD}, i_{SD}).

Kirchhoff's-Voltage-Law for Gate-Source gives ($i_G = 0$). $v_{SG} = -i_{SD} R_s$ For $-V_{po} < v_{SG} < 0$, then $i_{SD} = I_{SDS}(1 + v_{SG}/V_{po})^2$ $i_{SD} = I_{SDS}[1 + (-i_{SD} R_s)/V_{po}]^2$.

 $\begin{array}{ll} \mbox{Kirchhoff's-Voltage-Law on Drain} \\ \mbox{Side (the Load-Line Equation):} \\ & -V_{DD} + i_{SD} \left(R_d + R_s \right) + v_{SD} = 0 \\ \mbox{or} & v_{SD} = V_{DD} - i_{SD} (R_d + R_s) \end{array}$

ENHANCEMENT-MODE MOSFET CIRCUIT

Passive Drain Load on an Enhancement-Mode n-channel MOSFET

- Reverse Bias of Gate-Channel $0 < V_{on} < v_{GS}$ and $v_{DS} > 0$
- "On" for $i_{DS} > 0$ ($V_{on} < v_{GS}$) and "Off" for $i_{DS} = 0$ ($V_{on} > v_{GS}$)
- $v_{GS} = V_{GG} = V_i$ (since $i_G = 0$)

Analysis for Operating Point (v_{DS}, i_{DS}).

The Gate Voltage determines the Drain-Source Current ($v_{GS} = V_{GG} = V_i$). For $0 < V_{on} < v_{GS} = V_i$, then $i_{DS} = KV_{on}^2(v_{GS}/V_{on} - 1)^2$.

 $\begin{array}{l} \mbox{Kirchhoff's-Voltage-Law on Drain Side (the Load-Line Equation):} \\ - V_{DD} + i_{DS} \; R_d + v_{DS} \; = 0 \quad \mbox{or} \quad v_{DS} = V_{DD} - i_{DS} R_d \end{array}$

Note the inverter behavior. A low input voltage produces a high output voltage and a high input produces a low output.

DEPLETION-MODE MOSFET CIRCUIT

Depletion-Mode n-channel MOSFET as an Active Load

- Reverse Bias of Gate-Channel $v_{DS} > 0$
- Gate connected to the Source $v_{GS} = 0$

Analysis for Operating Point (v_{DS}, i_{DS}).

- The Gate Voltage determines the Drain-Source Current ($v_{GS} = 0$). $i_{DS} = I_{DSS}[2(1 + 0) (v_{DS}/V_{po}) - (v_{DS}/V_{po})^2] \& i_{DS} = I_{DSS}(1 + 0)^2$.
- $$\label{eq:constraint} \begin{split} \text{Kirchhoff's-Voltage-Law on Drain Side (the Load-Line Equation):} \\ \text{-} V_{DD} + V_{SS} + v_{DS} = 0 \quad \text{or} \quad v_{DS} = V_{DD} V_{SS} \end{split}$$

ENHANCEMENT-MODE MOSFET INVERTER CIRCUIT

Active Drain Load on an Enhancement-Mode n-channel MOSFET

- Enhancement-Mode MOSFET with Input $V_i = v_{GS1}$
- Depletion-Mode MOSFET with $v_{GS2} = 0$

Analysis for Vo vs. Vi

Kirchhoff's-Voltage-Law (the Load-Line Equation): $-V_{DD} + v_{DS2} + v_{DS1} = 0$ or $v_{DS1} = V_{DD} - v_{DS2}$

Extremes

Input High $V_i = v_{GS1} >> V_{on}$ (such that $v_{DS2} > V_{po}$), (MOSFET 1Unsaturated and MOSFET 2 Saturated) $i_{DS1} = i_{DS2} = I_{DSS2}$; then (LL) v_{DS1} approaches 0 V

ENHANCEMENT-MODE MOSFET INVERTER CIRCUIT

Active Drain Load on an Enhancement-Mode n-channel MOSFET

Progression

For $V_i = v_{GS1} \le V_{on}$, $i_{DS1} = i_{DS2} = 0$; then $v_{DS2} = 0$ and (LL) $v_{DS1} = V_{DD}$ (MOSFET 1 "Off" and MOSFET 2 "Off") Low Input and High Output

For $V_i = v_{GS1} = V_{on}^+$ and $v_{DS2} < V_{po}$, $i_{DS1} = i_{DS2} < I_{DSS2}$; (MOSFET 1 Saturated and MOSFET 2 Unsaturated)

For $V_i = v_{GS1} > V_{on}^+$ and $v_{DS2} \ge V_{po}$, $i_{DS1} = i_{DS2} = I_{DSS2}$; (MOSFET 1 Saturated and MOSFET 2 Saturated)

 $\begin{array}{l} \mbox{For } V_i = v_{GS1} >> V_{on} \mbox{ and } v_{DS2} \sim V_{DD}, \mbox{ } i_{DS1} = i_{DS2} = I_{DSS2}; \\ \mbox{(MOSFET 1Unsaturated and MOSFET 2 Saturated)} \\ \mbox{ High Input and Low Output} \end{array}$

